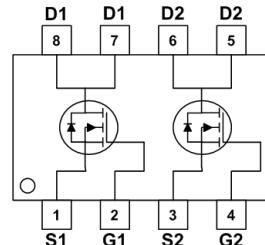
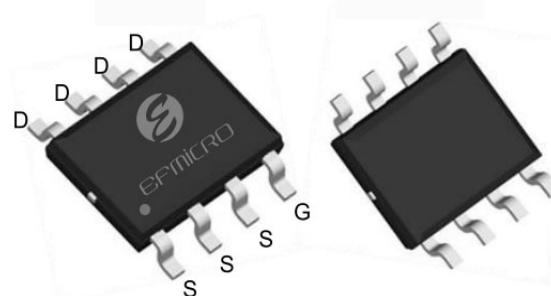


• Product Summary

Part #	V _{DS}	R _{DS(on).typ} (@V _{GS} =10V)	R _{DS(on).typ} (@V _{GS} =4.5V)	I _D
EFM4822A	30V	15mΩ	21mΩ	8.5A


• Description

- The EFM4822A is the high cell density trenched
- N-ch MOSFETs which provide excellent
- RDSON and gate charge for most of the
- synchronous buck converter applications.
- The EFM4822A meet the RoHS and Green
- Product requirement, 100 % EAS guaranteed
- with full function reliability approved.

Dual N-Channel MOSFET

SOP-8
• Ordering Information:

Part NO.	EFM4822A
Marking	4822 *****
Packing Information	REEL TAPE
Basic ordering unit (pcs)	3000

• Absolute Maximum Ratings (T_C=25°C)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	30	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	I _D	8.5	A
Drain Current-Pulsed ^(Note 1)	I _{DM}	37	A
Maximum Power Dissipation	P _D	1.5	W
Operating Junction and Storage Temperature Range	T _J , T _{STG}	-55 To 150	°C

• Thermal Characteristic

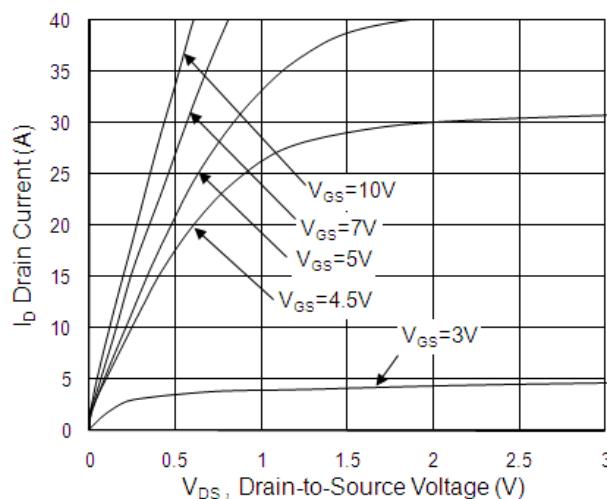
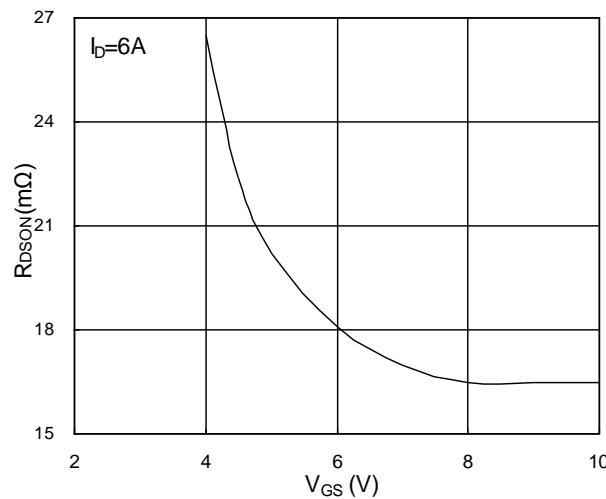
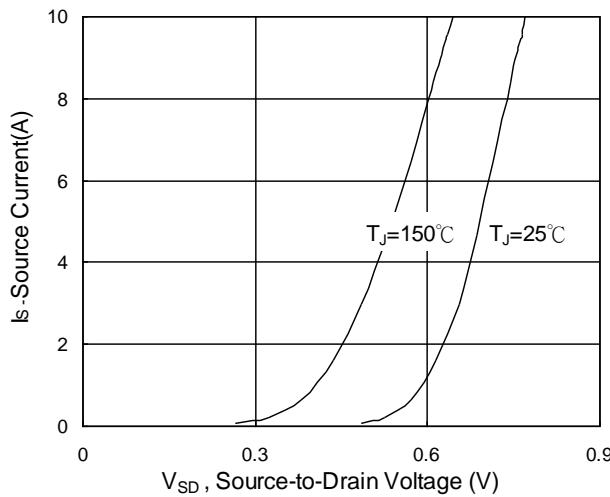
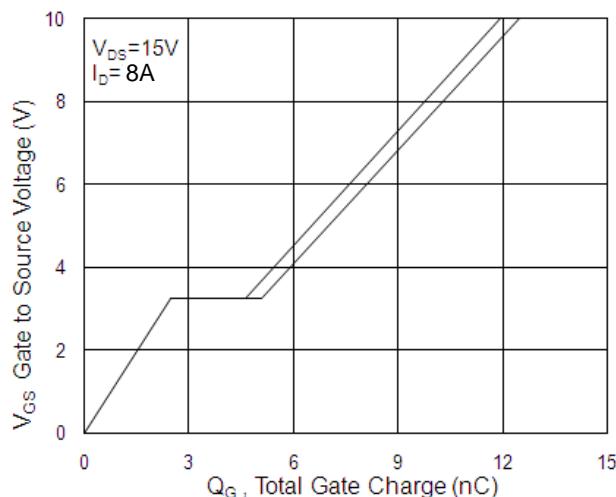
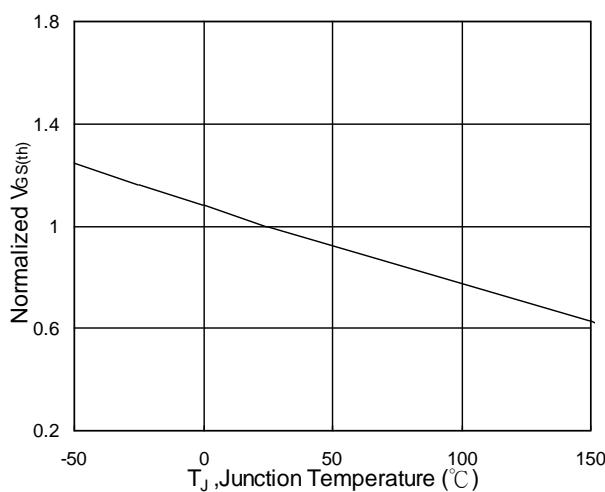
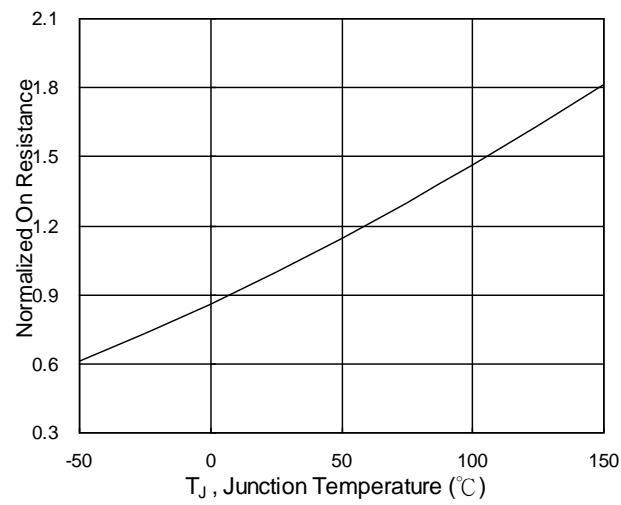
Thermal Resistance, Junction-to-Ambient ^(Note 2)	R _{θJA}	85	°C/W
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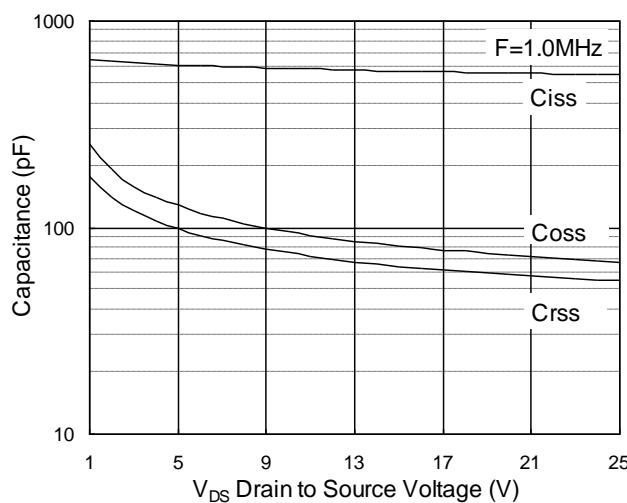
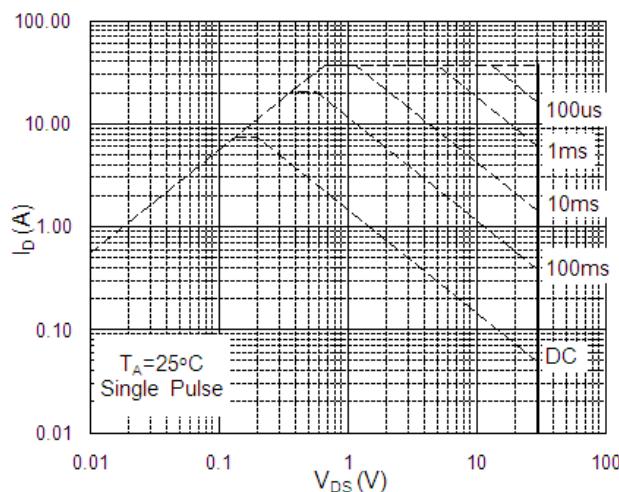
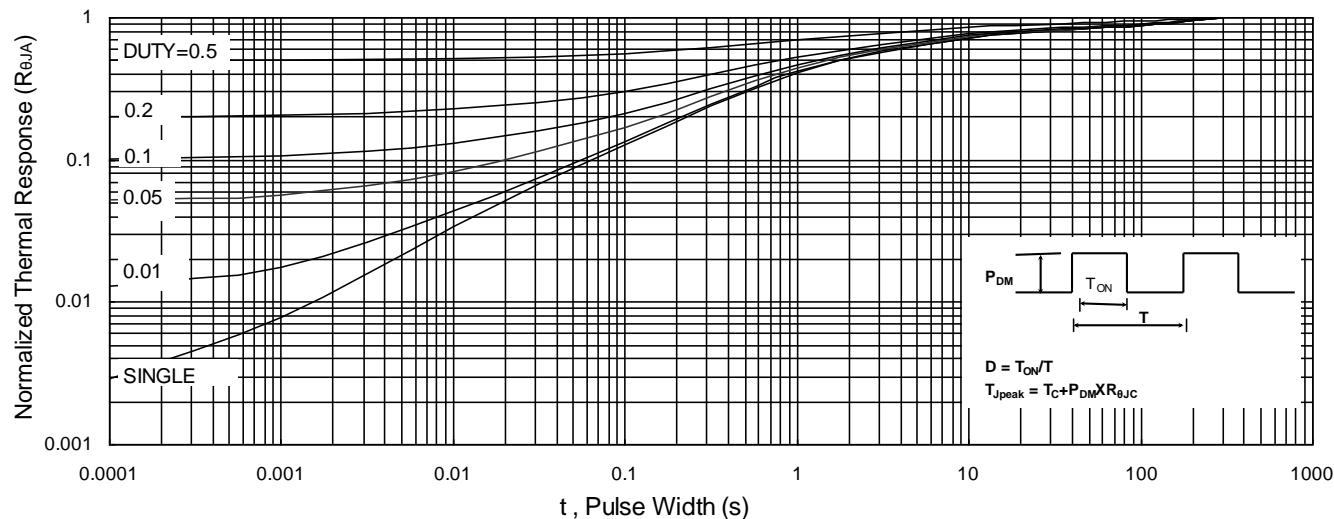
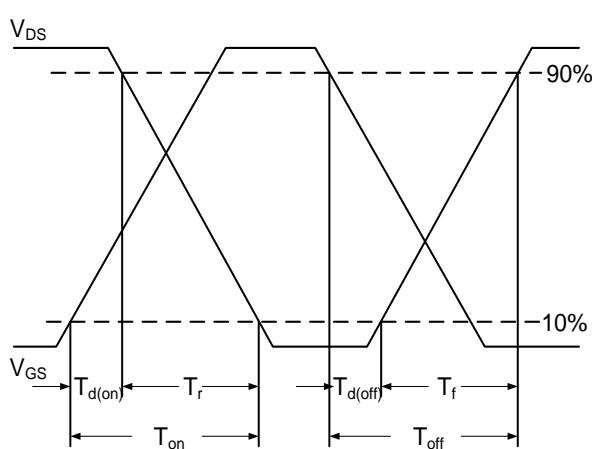
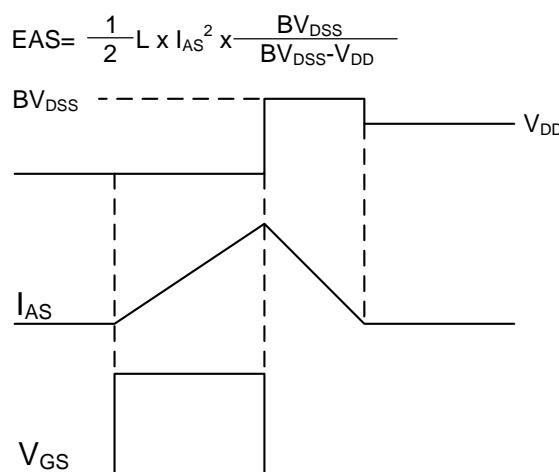
• Static Electrical Characteristics @ $T_J = 25^\circ C$ (unless otherwise stated)

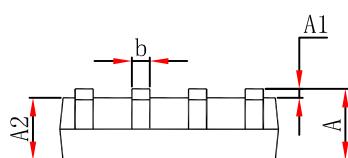
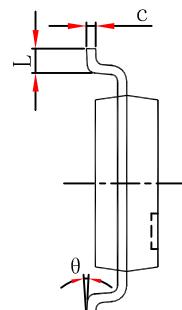
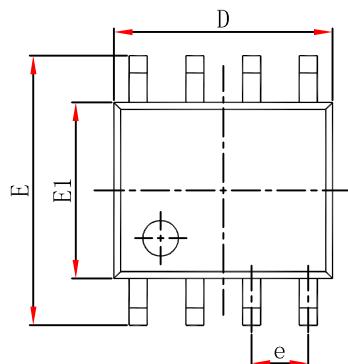
Parameter	Symbol	Condition	Min	Typ	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	V_{DSS}	$V_{GS}=0V I_D=250\mu A$	30	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=30V V_{GS}=0V$	--	--	1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{GS}=\pm 20V V_{DS}=0V$	--	--	± 100	nA
On Characteristics <small>(Note 3)</small>						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS} I_D=250\mu A$	1.2	--	2.5	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=10V I_D=8A$	--	15	18	$m\Omega$
		$V_{GS}=4.5V I_D=6A$	--	21	26	$m\Omega$
Forward Transconductance	g_{FS}	$V_{DS}=5V I_D=8A$	--	30	--	S
Gate Resistance	R_g	$F=1.0MHz$	--	2.5	--	Ω
Dynamic Characteristics <small>(Note 4)</small>						
Input Capacitance	C_{iss}	$V_{DS}=15V V_{GS}=0V$ $F=1.0MHz$	--	740	--	PF
Output Capacitance	C_{oss}		--	110	--	PF
Reverse Transfer Capacitance	C_{rss}		--	82	--	PF
Switching Characteristics <small>(Note 4)</small>						
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=15V I_D=8A$ $V_{GS}=10V R_G=3.3\Omega$	--	2.4	--	nS
Turn-on Rise Time	t_r		--	7.8	--	nS
Turn-Off Delay Time	$t_{d(off)}$		--	22	--	nS
Turn-Off Fall Time	t_f		--	4	--	nS
Total Gate Charge	Q_g	$V_{DS}=15V I_D=-8A$ $V_{GS}=10V$	--	6	--	nC
Gate-Source Charge	Q_{gs}		--	2.5	--	nC
Gate-Drain Charge	Q_{gd}		--	2.1	--	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage <small>(Note 3)</small>	V_{SD}	$V_{GS}=0V I_S=8A$	--	0.85	1.2	V
Diode Forward Current <small>(Note 2)</small>	I_S		--	--	8	A

Note :

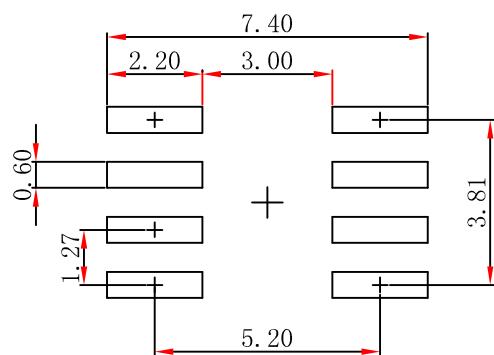
- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
- 3.The EAS data shows Max. rating . The test condition is $V_{DD}=25V, V_{GS}=10V, L=0.1mH, I_{AS}=21A$
- 4.The power dissipation is limited by $150^\circ C$ junction temperature
- 5.The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.

• Typical Characteristics

Fig.1 Typical Output Characteristics

Fig.2 On-Resistance vs. G-S Voltage

Fig.3 Forward Characteristics Of Reverse

Fig.4 Gate-Charge Characteristics

Fig.5 Normalized $V_{GS(th)}$ vs. T_J

Fig.6 Normalized $R_{DS(on)}$ vs. T_J


Fig.7 Capacitance

Fig.8 Safe Operating Area

Fig.9 Normalized Maximum Transient Thermal Impedance

Fig.10 Switching Time Waveform

Fig.11 Unclamped Inductive Switching Waveform

SOP8 Package Outline Dimensions


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.450	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.007	0.010
D	4.700	5.100	0.185	0.201
e	1.270 (BSC)		0.050 (BSC)	
E	5.800	6.200	0.228	0.244
E1	3.800	4.000	0.150	0.157
L	0.400	1.270	0.016	0.050
θ	0°		8°	


Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.